

STATUS OF CLAIMS

Claims 1-27 are pending.

PLEASE AMEND THE CLAIMS AS FOLLOWS:

<sup>25</sup> ~~25~~. The method of Claim <sup>17</sup> ~~17~~ wherein said low dielectric constant material is a hydrogen silsesquioxane spin-on-glass dielectric material.

<sup>26</sup> ~~26~~. The method of Claim <sup>17</sup> ~~17~~ wherein said low dielectric constant material is a carbon bonded hydrogen silsesquioxane spin-on-glass dielectric material.

<sup>27</sup> ~~27~~. The method of Claim <sup>17</sup> ~~17~~ wherein said low dielectric constant material is a carbon bonded fluorocarbon silsesquioxane spin-on-glass dielectric material.

Add claim 28 as follows:

<sup>28</sup> ~~28~~. The method of Claim <sup>17</sup> ~~17~~ wherein said low dielectric constant material is a silsesquioxane spin-on-glass dielectric material.